

STP35N60M2-EP

N-channel 600 V, 0.110 Ω typ., 26 A MDmesh™ M2 EP Power MOSFET in a TO-220 package

Datasheet - production data

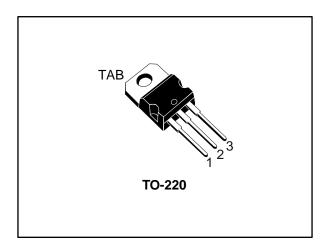
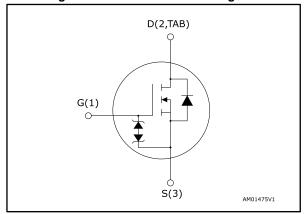


Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{Jmax}	R _{DS(on)} max.	Ι _D
STP35N60M2-EP	650 V	0.130 Ω	26 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications
- Tailored for very high-frequency converters (f > 150 kHz)

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STP35N60M2-EP	35N60M2EP	TO-220	Tube

May 2017 DocID030578 Rev 1 1/14

Contents STP35N60M2-EP

Contents

1	Electric	cal ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	·cuits	9
4	Packag	e information	10
	4.1	TO-220 type A package information	11
5	Revisio	n history	13



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STP35N60M2-EP Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±25	V
I_D	Drain current (continuous) at T _C = 25 °C	26	Α
ΙD	Drain current (continuous) at T _C = 100 °C	16	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	70	Α
Ртот	Total dissipation at T _C = 25 °C	190	W
dv/dt ⁽²⁾	Peak diode recovery	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case		°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or non-repetitive (pulse width limited by T _{jmax})	5	А
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	500	mJ

 $^{^{(1)}}$ Pulse width is limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 26$ A, di/dt ≤ 400 A/µs, V_{DS peak} < V_{(BR)DSS}, V_{DD} = 400 V

 $^{^{(3)}}V_{DS} \le 480 \text{ V}$

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			100	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 13 A		0.110	0.130	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1750	1	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	-	97	ı	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2.5	-	pF
Coss eq. (1)	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0 V	-	204	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	5	1	Ω
Q_g	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 26 \text{ A},$	-	41	-	nC
Qgs	Gate-source charge	V _{GS} = 0 to 10 V (see Figure 16: "Test circuit	-	7	1	nC
Q_{gd}	Gate-drain charge	for gate charge behavior")	-	20	-	nC

Notes:

Table 7: Switching energy

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
F	Turn-off energy	$V_{DD} = 400 \text{ V}, I_D = 4 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	ı	22	ı	μJ
E _(off)	(from 90% V _{GS} to 0% I _D)	$V_{DD} = 400 \text{ V}, I_D = 10 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	44	-	μJ

⁽¹⁾Defined by design, not subject to production test

 $^{^{(1)}}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 8: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 13 \text{ A},$	ı	16.5	1	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 15: "Test circuit for	ı	13.5	ı	ns
t _{d(off)}	Turn-off-delay time	resistive load switching times"	-	70	-	ns
t f	Fall time	and Figure 20: "Switching time waveform")	-	7	-	ns

Table 9: Source drain diode

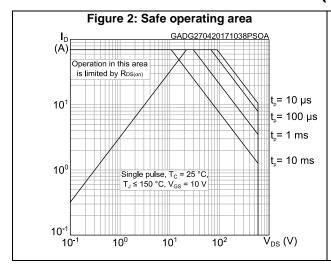
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		26	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		1		70	Α
V _{SD} ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 26 A	-		1.6	V
t _{rr}	Reverse recovery time	$I_{SD} = 26 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	273		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ (see Figure 17: "Test circuit for	-	3.6		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	26.5		Α
t _{rr}	Reverse recovery time	$I_{SD} = 26 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	400		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 17: "Test circuit for	-	6.3		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	31.5		А

Notes:

⁽¹⁾Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)



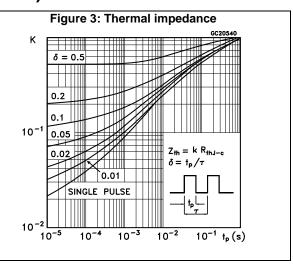
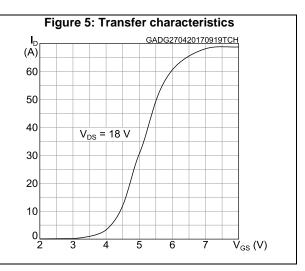
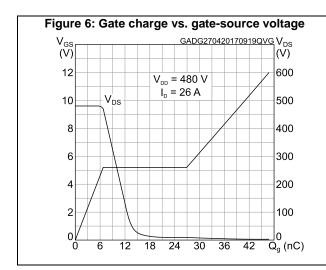
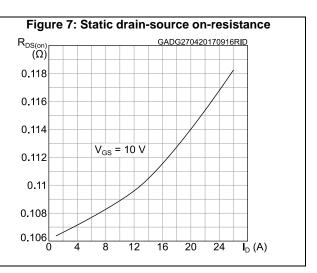


Figure 4: Output characteristics GADG270420170918OCH **I**_□ (A) $V_{GS} = 8, 9, 10 V$ $\widehat{V}_{GS} = 7 V^{-1}$ 60 V_{GS} = 6 V 50 40 30 $V_{GS} = 5 V$ 20 10 0 8 12 16 $\overline{V}_{DS}(V)$



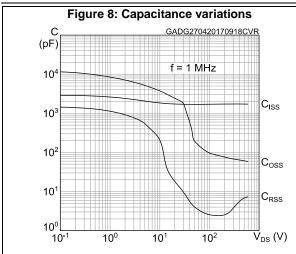




DocID030578 Rev 1

6/14

STP35N60M2-EP Electrical characteristics



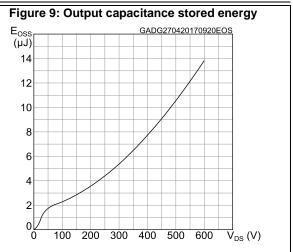
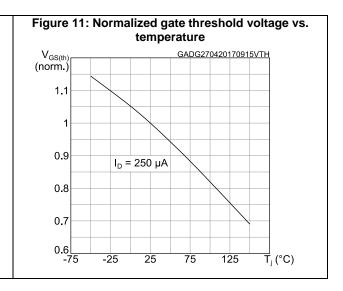
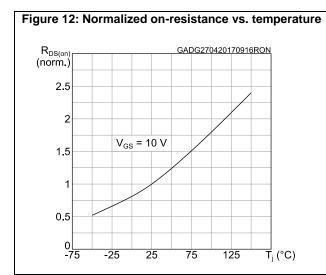
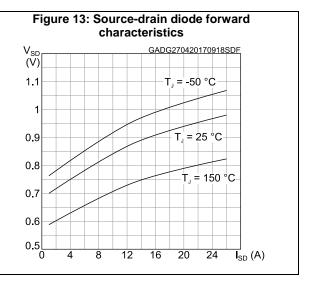
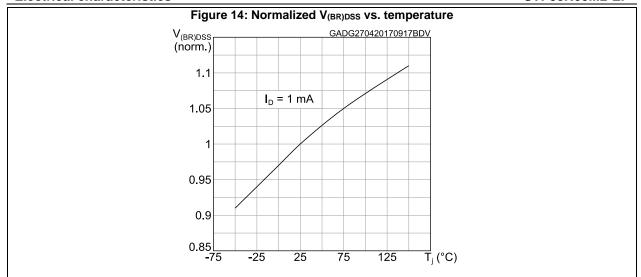


Figure 10: Turn-off switching energy vs. drain current $\mathsf{E}_{\mathsf{off}}$ (µJ) $V_{DD} = 400 \text{ V},$ 50 $V_{GS} = 10 \text{ V}$ $R_G = 4.7 \Omega$ 40 30 20 10 0L 0 8 10 $I_D(A)$ 6



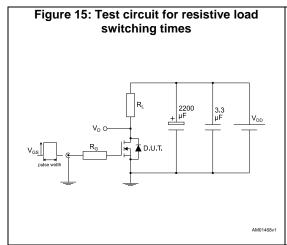






STP35N60M2-EP Test circuits

3 Test circuits



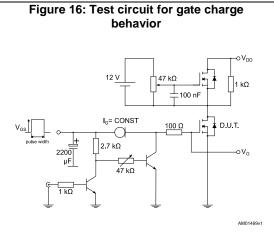
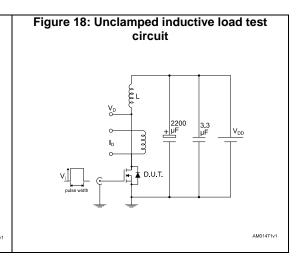
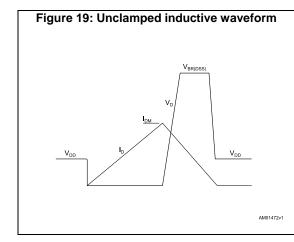
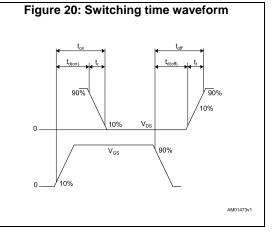


Figure 17: Test circuit for inductive load switching and diode recovery times

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4 Package information

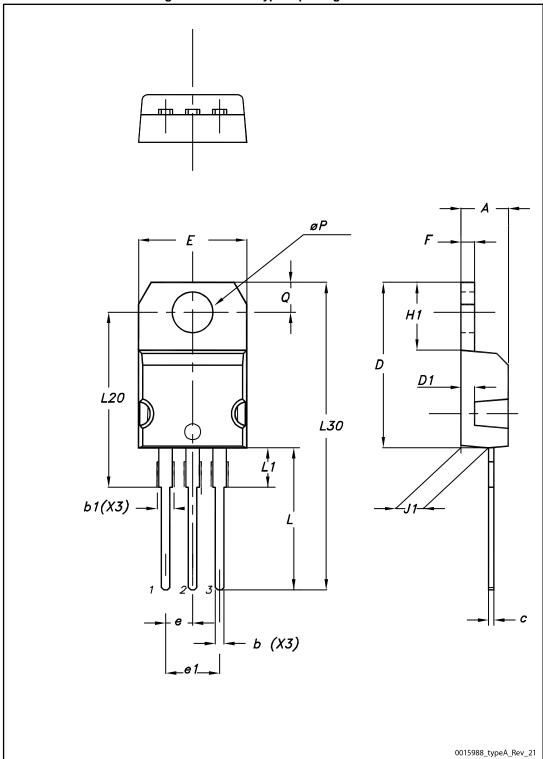
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577

STP35N60M2-EP Package information

4.1 TO-220 type A package information

Figure 21: TO-220 type A package outline



577

Table 10: TO-220 type A package mechanical data

	14210 101 10 120 1990 71	mm			
Dim.	Min.	Тур.	Max.		
А	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.55		
С	0.48		0.70		
D	15.25		15.75		
D1		1.27			
Е	10.00		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13.00		14.00		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
øΡ	3.75		3.85		
Q	2.65		2.95		

STP35N60M2-EP Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
02-May-2017	1	First release

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